

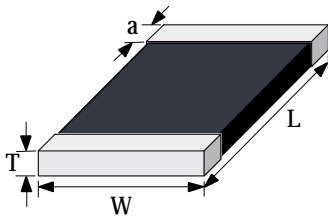
PolyDiode 0805 SMD D Series

ESD、EFT、Surge Suppressor & EMI/RFI Filter

Specifications



Dimensions



| SYMBOL | INCHES | | MILLIMETERS | |
|-------------------|--------|-------|-------------|------|
| | MIN | MAX | MIN | MAX |
| T _{max.} | - | 0.047 | - | 1.20 |
| a | 0.006 | 0.026 | 0.15 | 0.65 |
| L | 0.071 | 0.087 | 1.80 | 2.20 |
| W | 0.043 | 0.055 | 1.10 | 1.40 |

Features

- As JumboTek's electrical advantages and physical Advantages <For More> 2005.12.22
- Bidirectional clamping in a two pin device
- No polarity, suitable for uni- and bidirectional lines
- Adequate to replace a silicon TVS diode + EMC capacitor combination.
- Reducing board space and mounting cost
- Capable of withstanding numerous ESD strikes
- RoHS compliant

Applications examples

- Desktop and Note PC
- Mobile communication
- CD/MD/MP3 player
- LCD panel
- Touch panel
- Digital camera
- Button and switch unit
- Battery terminal
- Game machine
- Microphone/ receiver unit
- Audio-Video input-output terminal
- Portable handheld product (e.g. PDA)

WebLinks

Further infos see:
www.jumbotek.com
 Further technical infos
 Please E-mail: service@jumbotek.com

Packaging

Tape and Reel
 T 7 inch reel (3,000 pcs.)

Material

Body: Semiconducting Ceramic
 Terminals: Ni/Sn plated (code "P")

Operating Temperature

-55 to +125°C

Solderability

acc. to IEC 60068-2-58
 235°C, 2 sec.

Soldering Heat Resistance

260°C, 10 sec. (IEC 60068-2-58)
 280°C, 5 sec. (IEC 60068-2-58)

Response Time

<0.5ns

Temperature coefficient (αV) of clamping voltage (V_c) @ specified test current

<0.01%/ °C

Power dissipation

0.10 W max.

Standards

IEC 61000-4-2
 IEC 61000-4-3
 IEC 61000-4-4
 IEC 61000-4-5

| Type | Maximum Ratings (125°C) | | | | Specifications (25°C) | | | | | |
|----------------|----------------------------|------------------------|--|----------------------|--|--|--|----------------------------|------------------------|------------------------|
| | max. cont. working voltage | | max. non-repetitive surge current (8/20 μ s) | Peak Power (max.Ipp) | max. clamping voltage at Ipp (10/1000 μ s) | | Nominal voltage at 1mA (DC) test current | typ. capacitance 1MHz | max. inductance | |
| | V _{M(DC)} (V) | V _{M(AC)} (V) | I _{TM} (A) | (W) | V _c (V@A) | | V _{N(DC)min.} (V) | V _{N(DC)max.} (V) | C _{typ.} (pF) | L _{typ.} (nH) |
| PD05S5R6D192PT | 3.3 | 2.5 | 40 | 24 | 9.6@ 2.5 | | 3.80 | 7.00 | 1900 | 1.0 |
| PD05S6R2D182PT | 3.3 | 2.5 | 40 | 24 | 9.6@ 2.5 | | 3.80 | 7.00 | 1800 | 1.0 |
| PD05S9R1D721PT | 5.5 | 4.0 | 40 | 24 | 14.0@ 1.7 | | 7.91 | 9.56 | 720 | 1.0 |
| PD05S100D721PT | 5.5 | 4.0 | 40 | 24 | 14.0@ 1.7 | | 8.73 | 10.50 | 720 | 1.0 |
| PD05S120D651PT | 9.0 | 6.0 | 40 | 40 | 17.0@ 2.4 | | 10.20 | 12.60 | 650 | 1.0 |
| PD05S150D651PT | 9.0 | 6.0 | 40 | 40 | 21.0@ 1.9 | | 12.73 | 15.75 | 650 | 1.0 |
| PD05S180D481PT | 12.0 | 9.0 | 40 | 40 | 25.0@ 1.6 | | 15.45 | 18.90 | 480 | 1.0 |
| PD05S200D381PT | 14.0 | 11.0 | 40 | 40 | 28.0@ 1.4 | | 17.27 | 21.00 | 380 | 1.0 |
| PD05S270D291PT | 18.0 | 14.0 | 40 | 40 | 40.0@ 1.0 | | 23.64 | 28.35 | 290 | 1.0 |
| PD05S330D291PT | 26.0 | 20.0 | 40 | 40 | 46.0@ 0.87 | | 29.09 | 34.65 | 290 | 1.0 |

How to order

| PD | 05 | S | 5R6 | D | 192 | P | T |
|-----------|----------------------------|-------------|---------------------------|------------------------|---|-------------------------------|-------------------------|
| Type code | Chip Size | Single Chip | Nominal voltage Breakdown | Diode-mode application | Capacitance Code | Termination Code | Packing Code |
| PolyDiode | 03= EIA0603 05= EIA0805 | | Voltage at 1mA (DC) | | 192= 19×10 ² 721= 72×10 ¹ 651= 65×10 ¹ | P: Electroplating by Ni/Sn | T: Tape&Reel B: Bulk |